Current Sensing Chip Resistors

NCSP Series

FEATURES

- SURFACE MOUNTABLE, MOLDED FLAT PACK
- ULTRA LOW VALUES $(3m\Omega \sim 1\Omega)$
- EXTEND TEMPERATURE RANGE (+180°C)
- Pb-FREE REFLOW COMPATIBLE

RoHS Compliant includes all homogeneous materials



*See Part Number System for Details

CHARACTERISTICS

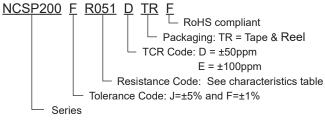
Туре	Size	Power Rating	Resistance	Temperature	Resistance	Resistance	Operating
		at 70°C	Tolerance	Coefficient (°C)	Range	Range (Codes)	Temp. Range (°C)
NCSP100S	6.3 x 3.2	1 Watt		$0.051\Omega \sim 0.100\Omega$: ±50ppm For Values	0.003Ω ~ 0.200Ω	R003 ~ R200	-55°C ~ +155°C
NCSP100L	7.5 x 4.5	i vvali	1% (F)		0.003Ω ~ 0.510Ω	R003 ~ R510	
NCSP200	12.5 X 6.0	2 Watt	5% (J)		0.005Ω ~ 1.000Ω	R005 ~ 1R00	-55°C ~ +180°C
NCSP300	14.5 X 8.0	3 Watt			0.005Ω ~ 1.800Ω	R005 ~ 1R80	

Operating Voltage: V Power rating (Watts) x Resistance (Ohms)

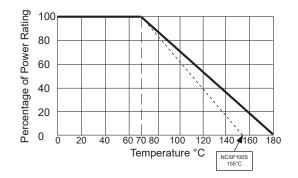
Short Time Overload Voltage: 2x // Power rating (Watts) x Resistance (Ohms)

Operating Current: // Power rating (Watts) / Resistance (Ohms)

PART NUMBER SYSTEM

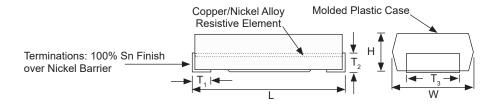


Power Derating Curve: For operation above 70°C, power rating must be derated according to the following chart:



DIMENSIONS (mm)

Туре	L ± 0.5	W ± 0.3	H ± 0.3	T ₁ ±0.3	$T_{2} \pm 0.3$	$T_{_{3}} \pm 0.3$
NCSP100S	6.3	3.2	1.0	0.8	0.8	3.2
NCSP100L	7.5	4.5	2.0	1.2	1.1	2.5
NCSP200	12.5	6.0	3.0	2.0	1.5	4.0
NCSP300	14.5	8.0	3.0	2.0	1.5	6.0





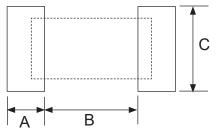
Item	Specification	Test Method	
Temperature Coefficient of Resistance	As Specified	Measured from 20°C through a temperature range of -55°C ~ +125°C	
Short Time Overload	∆R < 0.5%	Applied voltage equivalent to 2x the rated power for 10 minutes	
Withstanding Voltage (Between terminations and center of component body)	∆R < 0.2% with no evidence of insulation breakdown	500VAC for 1 minute	
Insulation Resistance (Between terminations and center of component body)	>100MΩ	100VDC	
Resistance to dry heat	∆R < 0.5%	260°C ± 5°C for 10 seconds	
Humidity (Steady State)	$\Delta R < 0.5\%$ IR > 20M Ω No Mechanical Damage	+40°C, 90~95% RH for 1,000 hours	
Endurance (1,000 hours)	∆R < 1.0% No mechanical damage	Rated power at 70°C Power on 90 minutes Power off 30 minutes	
Temperature Cycling (5 cycles)	∆R < 0.5% No mechanical damage	-55°C 30 minutes +25°C 3 minutes +155°C 30 minutes +25°C 3 minutes	
Resistance to Soldering Heat	∆R < 0.5% No mechanical damage	260°C ± 5°C for 10 seconds	
Vibration	∆R < 0.5% No mechanical damage	1.5mm in X, Y, Z axis 10Hz ~ 55Hz ~ 10Hz 1 minute sweep for 2 hours in each direction	
Solderability	Coverage of more than 75% of termination	245°C ± 5°C for 2 seconds Solder: Sn3Ag0.5Cu	

ENVIRONMENTAL SPECIFICATIONS



Current Sensing Chip Resistors

LAND PATTERN DIMENSIONS (mm) Туре А В С NCSP100S 2.0 3.2 3.0 NCSP100L 2.0 4.5 3.0 NCSP200 2.8 7.9 4.5 NCSP300 2.8 9.9 6.5



Reflow Soldering Heat Profile and Limits

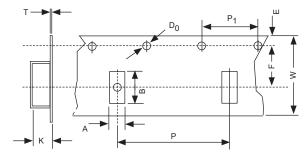
→ www.niccomp.com/resource/files/resistive/NIC-ChipR-Reflow-Sept2020-Rev2.pdf Wave soldering? – Please review your wave soldering process profile with NIC: tpmg@niccomp.com

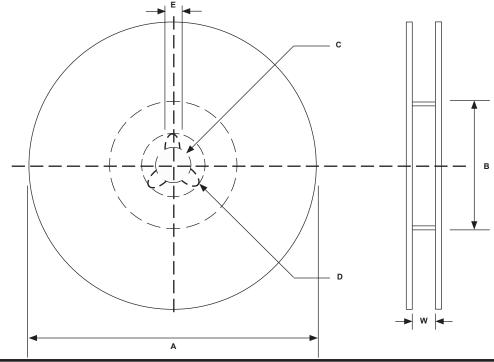
EMBOSSED PLASTIC CARRIER DIMENSIONS (mm)

Туре	A ±0.1	B ±0.1	P ±0.1	P ₁ ±0.1	K ±0.1	W ±0.2	F ±0.1	E ±0.1	D _o +0.1	T ±0.05
NCSP100S	3.6	6.8			1.3	12.0	5.5			
NCSP100L	5.1	8.2	8.0	4.0	2.5	16.0	7.5	1.75	1.50	0.3
NCSP200	6.6	13.2				24.0	11.5			
NCSP300	8.6	15.2			3.5	24.0				

REEL DIMENIONS (mm) AND QUANTITY

Туре	А	В	С	W	Quantity	
NCSP100S	180±2.0	60		13.0 ±0.5		
NCSP100L	100±2.0	60	13.0 ±0.5	17.5 ±0.5	1,000	
NCSP200	254±0.3	90 I 0 F	13.0 ±0.5	25.5 ±0.5		
NCSP300	330 ±0.2	80 ±0.5		25.5 ±0.5		





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